

**Instrumentation SIG Project Team
Project Team Meeting, 5 May 2015
Meeting Notes by Ray Topping, Fiotech**

We had seven people on the call, as noted in the participation list below.

1. Identification of new chairperson – Ray

Nils Sandsmark offered that PCA's STI project will propose a candidate for the new chairperson. They are intending the individual be an Owner's representative from their advisory team. Nils expects to have that recommendation by the end of the month.

2. Follow up on the document shared by Hindrik – Ravi

Feedback is being provided by Andrew Prosser. Andy was not available for the call. Hindrik was not available for the call today. Deferred to a later session.

3. Example of instrumentation diagram – Ravi

Deferred to a later session.

4. Discussion of example instrumentation diagram from DEXPI - Heiner Temmen

Heiner shared an example Instrumentation diagram and provided an overview and status for the DEXPI work. The DEXPI work is coordinating with Fiotech's IIMM Project. Also Heiner shared the functional class table.

Ray noted that DEXPI presented on their work at the Fiotech Annual Conference. The DEXPI presentation is available on the Fiotech web site at <http://fiotech.org/tech-conference-showcase-event/2015-tech-conference>

The DEXPI presentation is included in the session [Wednesday_Interoperability Improvements Advancing Productivity Breakout Session](#)

Ravi responded that the DEXPI work was similar to the work going forward with the Instrumentation SIG development.

Other topics – none were brought forward

It is desired to have the Fiotech IIMM team present at the next Instrumentation SIG Meeting with an overview and status on their project. Ray will follow up with Keith and will invite Andy to present at our next meeting.

Next Meeting, since we may have a new project leader at the end of the month, we will cancel the 19 May 2015.

Our next meeting will be the first Tuesday in June, 2nd June.

Participation List

	name	participated
1	Ravindra.Grampurohit, Emerson	X
2	Duane Toavs, Emerson	
3	Bhupati Panda, Emerson	
4	Nisha Garg, Emerson	
5	Keith Willshaw, Bentley	X
6	Lynsey Dryden, AVEVA	
7	Chris Binns, AVEVA	X

8	Hindrik Koning, xs4all	
9	Kanga, Darius, Bechtel	
10	Rob Brawn, CH2M HILL	x
11	Dan L. Carnahan, Rockwell	
12	Heiko Graf, Autodesk	
13	Roland Hancock Jr, Dow Chemical	
14	Michael Wiedau, rwth-aachen	
15	Manfred Theissen	
16	Heiner Temmen, Evonik	x
17	Manchester Meeting Room WebEx Room, AVEVA	
18	Ray Topping, Fiotech	x
19	Nils Sandsmark, PCA	x
20	Daijus Strasunskas, PCA	
21	Viktor Agroskin, TechInvestLabs	